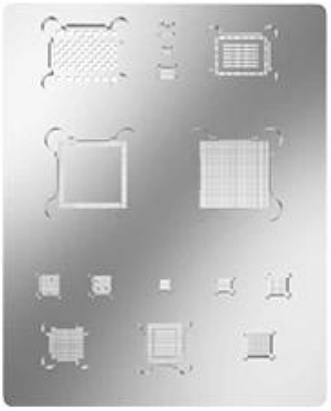
BEST-A9-High Quality Universal BGA IC-Chip-Schablonen erhitzte Schablone Reballing Schablone für iphone 6 6P

1x BGA Reballing Schablonen für iPhone 6s Plus

1x BGA Reballing Schablonen für iPhone 6s

Product Usage

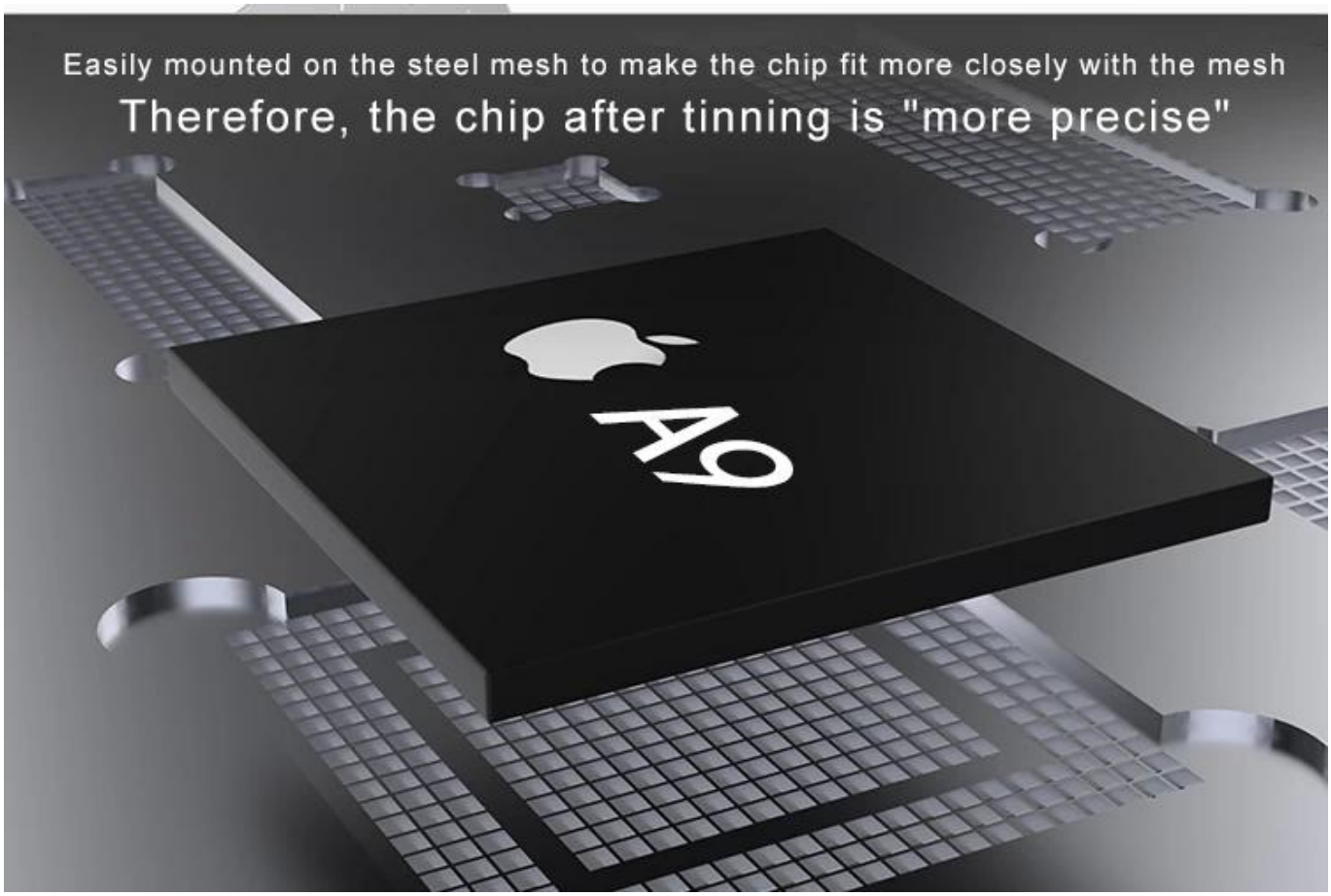


MODEL	A9
WEIGHT	18.8g
MATERIAL	imported steel
SIZE	68.9 X 84.9mm
MATCHING MACHINE TYPE	iPhone6S/6SPlus

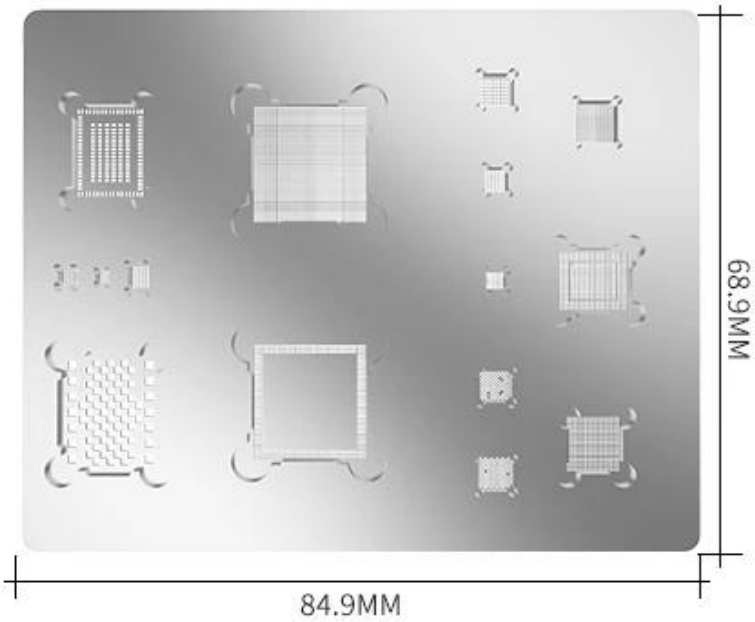
▼CHARACTERISTICS

This product is used for BGA tinning repair of the iPhone 6S/6sPlus series. Imported steel, anti-rolling anti-deformation, automatic alignment, accurate hole position, non-stick tin, good toughness, good off-grid.

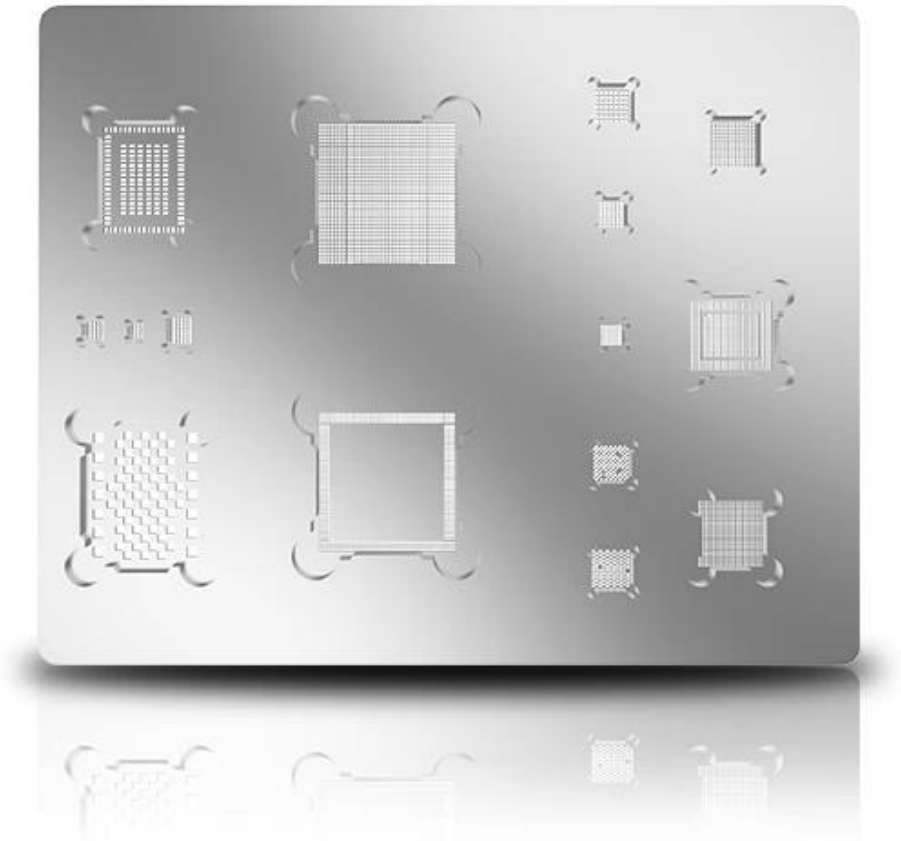
PRODUCT INFORMATION



PRODUCT SIZE



Thin to 0.31mm

Precise die-casting Iform heating

Applicable iPhone6S/6SPlus